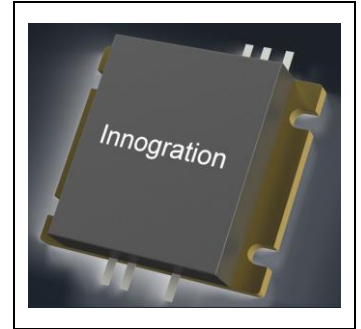




## 1.0-2.5GHz, 80W , 2 stages GaN Fully matched PA

### Description

The S2MBV1025-80H3P is a 80-watt Psat capable, 2 stage integrated IMFET, designed for broad band applications, with frequencies from 1.0 to 2.5GHz. The module is 50  $\Omega$  input/output matched and requires minimal external components, with DC block capacitor integrated inside. The module implements multiple GaN active dice and its matching network within highly compact 30.8\*27.4mm metal RF package with excellent capability for heat dissipation. It is recommended to be used for pulsed CW only



$V_{DS}= 50V, V_{gs1}= -3.26V, I_{dq1}=100mA, V_{gs2}= -2.6V, I_{dq2}=20mA$ pulsed CW: 20us,10%					
Freq (MHz)	P1(dBm)	P1 Gain ( dB )	P4dB(dBm)	P4dB(W)	EFF (%)
1000	47.53	26.0	49.13	81.8	43.4
1100	47.89	26.0	49.35	86.1	44.6
1200	48.21	25.7	49.63	91.7	47.0
1300	48.03	24.8	49.24	84.0	42.0
1400	48.19	24.1	50.18	104.3	43.3
1500	47.36	24.6	50.08	101.8	44.9
1600	47.12	25.0	49.80	95.4	44.8
1700	47.01	25.5	49.37	86.5	43.4
1800	47.19	25.9	49.08	81.0	43.1
1900	48.31	26.8	49.25	84.2	47.3
2000	48.45	27.0	49.54	90.0	47.4
2100	48.06	26.7	49.47	88.4	42.6
2200	47.60	26.3	49.33	85.6	42.6
2300	47.09	26.9	49.17	82.5	43.4
2400	46.79	27.4	49.13	81.8	42.8
2500	48.20	26.8	49.37	86.5	46.2

### Applications

- L/S band power amplifier
- Avionics power amplifier

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	$V_{DS}$	200	Vdc
Gate--Source Voltage	$V_{GS}$	-10 to +2	Vdc
Operating Voltage	$V_{DD}$	+55	Vdc
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Case Operating Temperature	$T_c$	+150	°C
Operating Junction Temperature	$T_j$	+225	°C

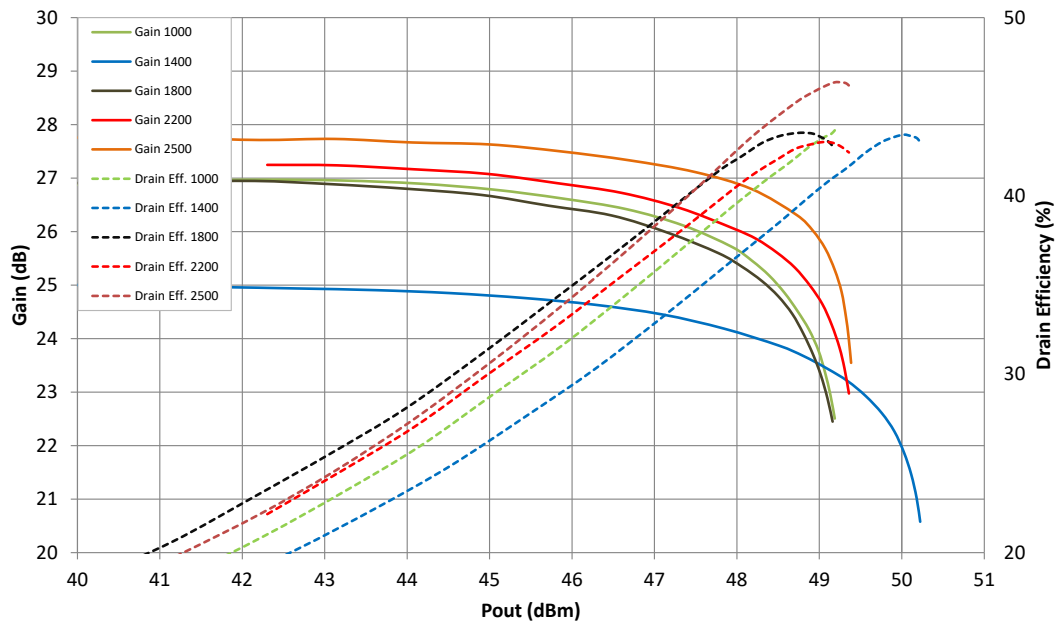


## TYPICAL CHARACTERISTICS

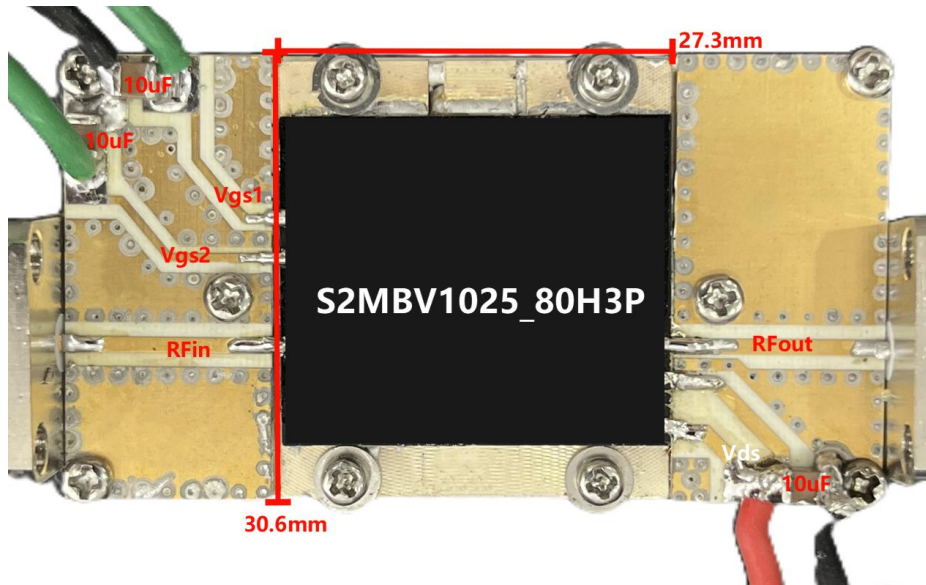
Figure 1. Network analyzer output S11/S21 (Pin=0dBm, Idq=200mA)



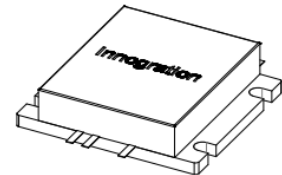
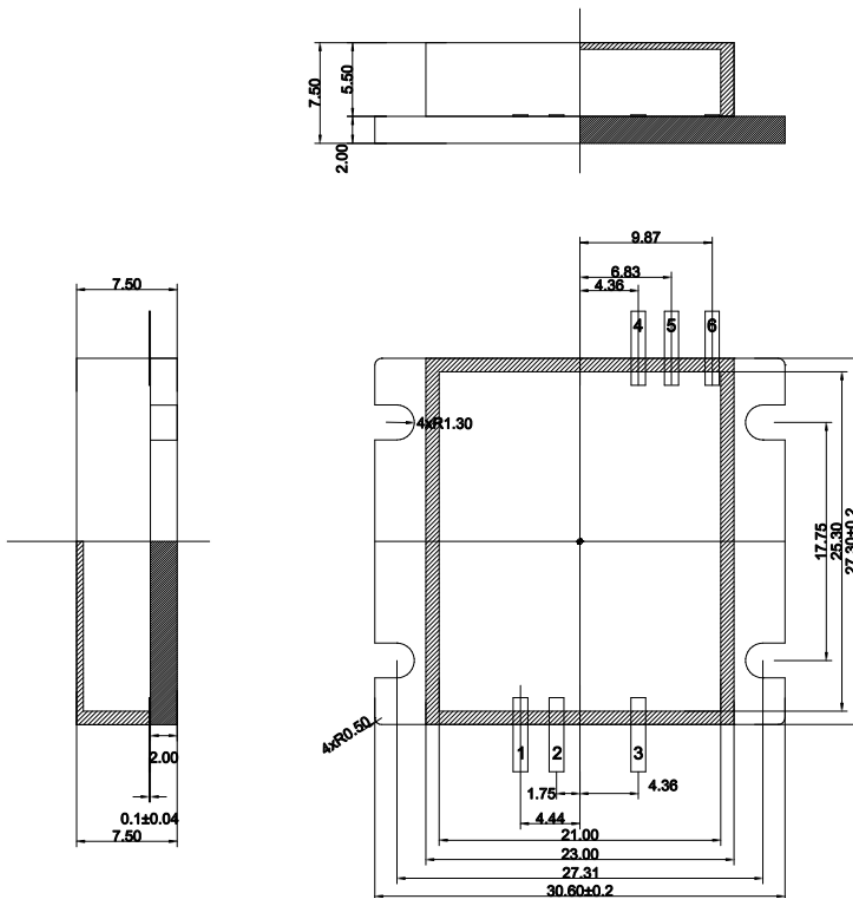
Figure 3. Pout, Eff, Gain, drain current Vs Frequency @50V ,Pulsed 20us 20%



## Typical application board



## Package Dimensions (Unit:mm)



Pin definition					
1	2	3	4	5	6
Vgs1	Vgs2	RFin	RFout	Vds1	Vds2



## Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2025/8/27	Rev 1.0	Advanced Datasheet

Application data based on HJ-25-12

## Disclaimers

Specifications are subject to change without notice. Innogrations believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogrations for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogrations . Innogrations makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. “Typical” parameters are the average values expected by Innogrations in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer’s technical experts for each application. Innogrations products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogrations product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogrations and authorized distributors

Copyright © by Innogrations (Suzhou) Co.,Ltd.